## N-Channel 60 V (D-S) MOSFET

| PRODUCT SUMMARY |  |  |  |
| :---: | :---: | :---: | :---: |
| $\mathbf{V}_{\mathbf{D S}}(\mathbf{V})$ | $\mathbf{R}_{\mathrm{DS} \text { (on) }}(\Omega)$ Max. | $\mathbf{I}_{\mathbf{D}}(\mathbf{A})$ | $\mathbf{Q}_{\mathbf{g}}$ (Typ.) |
| 60 | 0.073 at $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}$ | 18 | 19.8 |
|  | 0.085 at $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ | 15 |  |

## FEATURES

- TrenchFET ${ }^{\circledR}$ Power MOSFET
- $100 \% \mathrm{R}_{\mathrm{g}}$ and UIS Tested
- Material categorization: For definitions of compliance please see


## APPLICATIONS

- DC/DC Converters
- DC/AC Inverters
- Motor Drives


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| SPECIFICATIONS（ $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ ，unless otherwise noted） |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Test Conditions | Min． | Typ． | Max． | Unit |
| Static |  |  |  |  |  |  |
| Drain－Source Breakdown Voltage | $\mathrm{V}_{\mathrm{DS}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 60 |  |  | V |
| Gate Threshold Voltage | $\mathrm{V}_{\text {GS（th）}}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 1.0 |  | 3.0 |  |
| Gate－Body Leakage | $\mathrm{I}_{\text {GSS }}$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}$ |  |  | $\pm 250$ | nA |
| Zero Gate Voltage Drain Current | IDSS | $\mathrm{V}_{\mathrm{DS}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DS }}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{J}=125^{\circ} \mathrm{C}$ |  |  | 50 |  |
|  |  | $\mathrm{V}_{\mathrm{DS}}=60 \mathrm{~V}, \mathrm{~V}$ GS $=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=150^{\circ} \mathrm{C}$ |  |  | 250 |  |
| On－State Drain Current ${ }^{\text {a }}$ | $\mathrm{I}_{\mathrm{D} \text {（on）}}$ | $\mathrm{V}_{\mathrm{DS}} \geq 10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}$ | 20 |  |  | A |
| Drain－Source On－State Resistance ${ }^{\text {a }}$ | $\mathrm{R}_{\mathrm{DS} \text {（on）}}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=6.6 \mathrm{~A}$ |  | 0.073 |  | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=6 \mathrm{~A}$ |  | 0.085 |  |  |
| Forward Transconductance ${ }^{\text {a }}$ | $\mathrm{g}_{\text {fs }}$ | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=6.6 \mathrm{~A}$ |  | 25 |  | S |
| Dynamic ${ }^{\text {b }}$ |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | $\mathrm{V}_{\mathrm{DS}}=30 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 660 |  | pF |
| Output Capacitance | $\mathrm{C}_{\text {oss }}$ |  |  | 85 |  |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {rss }}$ |  |  | 40 |  |  |
| Total Gate Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{g}}$ | $\mathrm{V}_{\mathrm{DS}}=30 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=6.6 \mathrm{~A}$ |  | 19.8 | 30 | nC |
| Gate－Source Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{gs}}$ |  |  | 3.6 |  |  |
| Gate－Drain Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{gd}}$ |  |  | 4.1 |  |  |
| Gate Resistance | $\mathrm{R}_{\mathrm{g}}$ | $\mathrm{f}=1 \mathrm{MHz}$ | 0.4 | 2 | 4 | $\Omega$ |
| Turn－On Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=30 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=9.6 \Omega \\ \mathrm{I}_{\mathrm{D}} \cong 5.2 \mathrm{~A}, \mathrm{~V}_{\mathrm{GEN}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=1 \Omega \end{gathered}$ |  | 8 | 16 | ns |
| Rise Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{r}}$ |  |  | 11 | 20 |  |
| Turn－Off Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d} \text {（off）}}$ |  |  | 18 | 27 |  |
| Fall Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{f}}$ |  |  | 5 | 10 |  |
| Turn－On Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=30 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=9.6 \Omega \\ \mathrm{I}_{\mathrm{D}} \cong 5.2 \mathrm{~A}, \mathrm{~V}_{\mathrm{GEN}}=4.5 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=1 \Omega \end{gathered}$ |  | 38 | 57 |  |
| Rise Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{r}}$ |  |  | 58 | 87 |  |
| Turn－Off Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d} \text {（off）}}$ |  |  | 18 | 27 |  |
| Fall Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{f}}$ |  |  | 8 | 16 |  |
| Drain－Source Body Diode Ratings and Characteristics ${ }^{\text {b }} \mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| Continuous Current | $\mathrm{I}_{\text {S }}$ |  |  |  | 18 | A |
| Pulsed Current | $\mathrm{I}_{\text {SM }}$ |  |  |  | 25 |  |
| Forward Voltage ${ }^{\text {a }}$ | $\mathrm{V}_{S D}$ | $\mathrm{I}_{\mathrm{F}}=5.2 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  | 0.8 | 1.5 | V |
| Reverse Recovery Time | $\mathrm{trr}_{\text {r }}$ | $\mathrm{I}_{\mathrm{F}}=5.2 \mathrm{~A}, \mathrm{dl} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |  | 34 | 51 | ns |
| Peak Reverse Recovery Current | $\mathrm{I}_{\mathrm{RM}(\mathrm{REC})}$ |  |  | 3 | 5 | A |
| Reverse Recovery Charge | $\mathrm{Q}_{\mathrm{rr}}$ |  |  | 50 | 75 | nC |

## Notes：

a．Pulse test；pulse width $\leq 300 \mu \mathrm{~s}$ ，duty cycle $\leq 2 \%$ ．
b．Guaranteed by design，not subject to production testing．
c．Independent of operating temperature．
Stresses beyond those listed under＂Absolute Maximum Ratings＂may cause permanent damage to the device．These are stress ratings only，and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied．Exposure to absolute maximum rating conditions for extended periods may affect device reliability．

TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$ ，unless otherwise noted）


Output Characteristics


Transfer Characteristics


Transconductance


On－Resistance vs．Drain Current


On－Resistance vs．Gate－to－Source Voltage


Gate Charge

TYPICAL CHARACTERISTICS（ $25^{\circ} \mathrm{C}$ ，unless otherwise noted）


TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$ ，unless otherwise noted）


## TO－252AA Case Outline



|  | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
| DIM． | MIN． | MAX． | MIN． | MAX． |
| A | 2.18 | 2.38 | 0.086 | 0.094 |
| A1 | － | 0.127 | － | 0.005 |
| b | 0.64 | 0.88 | 0.025 | 0.035 |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 |
| C | 0.46 | 0.61 | 0.018 | 0.024 |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |
| D1 | 4.10 | － | 0.161 | － |
| E | 6.35 | 6.73 | 0.250 | 0.265 |
| E1 | 4.32 | － | 0.170 | － |
| H | 9.40 | 10.41 | 0.370 | 0.410 |
| e | 2．28 BSC |  | 0．090 BSC |  |
| e1 | 4．56 BSC |  | 0．180 BSC |  |
| L | 1.40 | 1.78 | 0.055 | 0.070 |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 |
| L4 | － | 1.02 | － | 0.040 |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 |
| ECN：T16－0236－Rev．P，16－May－16 DWG： 5347 |  |  |  |  |

Notes
－Dimension L3 is for reference only．

## RECOMMENDED MINIMUM PADS FOR DPAK（TO－252）



Recommended Minimum Pads
Dimensions in Inches／（mm）

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